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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/084,873	03/01/2002	Quinn K. Tong	1987.EEM	7243	
75	7590 08/25/2006			EXAMINER	
Charles W. Almer			ZARNEKE, DAVID A		
Counsel, I.P.			ADTIBUT	DADED MUMPED	
NATIONAL STARCH AND CHEMICAL COMPANY			ART UNIT	PAPER NUMBER	
10 Finderne Avenue			2891		
Bridgewater, NJ 08807-0500			DATE MAILED: 08/25/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
Office Action Comm	10/084,873	TONG ET AL.			
Office Action Summary	Examiner	Art Unit			
	David A. Zarneke	2891			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim rill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D. (35 U.S.C. § 133).			
Status					
Responsive to communication(s) filed on 13 Ju This action is FINAL . 2b) ☐ This Since this application is in condition for allowant closed in accordance with the practice under E	action is non-final.				
Disposition of Claims					
4) ☐ Claim(s) 1,3-22,24-32 and 34-39 is/are pending 4a) Of the above claim(s) 34-39 is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1,3-22 and 24-32 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	n from consideration.				
Application Papers					
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction and the original transfer of the property of the Examiner 11). The oath or declaration is objected to by the Examiner 11.	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori application from the International Bureau * See the attached detailed Office action for a list of	s have been received. s have been received in Application ity documents have been received (PCT Rule 17.2(a)).	on No ed in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)	_				
Paper No(s)/Mail Date 6)					

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DETAILED ACTION

Response to Arguments

Applicant's arguments with respect to claims 1, 3-22, and 24-32 have been considered but are most in view of the new ground(s) of rejection.

It is argued that the cited references don't teach the specific, newly claimed imidazole-anhydride.

The rejection now cites Hirose et al., US Patent 4,546,155, in order to reject this new limitation.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 1 is rejected under 35 U.S.C. 103(a) as being unpatentable over Gilleo et al., US Patent 6,194,788, in view of Kunitomi, JP 58103525 and Hirose et al., US Patent 4,546,155.

Gilleo teaches a B-stage-able underfill encapsulant (7, 54+) comprising:

- a) thermal curable resin system comprising an admixture of at least one epoxy, one preferably being biphenyl A (4, 7+);
 - b) a hardener such as acid anhydrides (4, 12+);

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c) at least one solvent (4, 40+);

- d) at least one inorganic filler (4, 23+); and
- e) at least one fluxing agent (4, 18+),

wherein the encapsulant solidifies during the B-stage process to produce a smooth, non-tacky surface on a semiconductor wafer (4, 3+) or silicon chip.

The B-stage encapsulant of Gilleo inherently produces a smooth, non-tacky surface because Applicant's own specification states that B-stage means that the underfill must be solidified after its placement on a wafer to provide a smooth, non-tacky coating (page 3, last line and page 4, top).

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Gilleo fails to teach the use of an imidazole-anhydride adduct as the hardener.

Kunitomi teaches an epoxy resin composition (abstract) comprising an epoxy resin; a phenol containing compound, namely a phenol novolak resin; a 2-methylimidazole/pyromellitic anhydride complex curing agent; and an inorganic filler (page 233, 2nd column, 4th to last line). Kunitomi teaches the use of a 2-phenyl imidazole, which is a non-N-substituted imidazole taught by the present app (9, 23+), in place of the 2-methylimidazole.

It would have been obvious to one of ordinary skill in the art to use the curing promoting agent of Kunitomi in the invention of Gilleo because Kunitomi teaches that the anhydride-imidazole complex provides long-term storage stability.

Kunitomi fails to teach the imidazole as being 2-phenyl-4-methyl imidazole.

Hirose teaches the equivalence of 2-phenyl-4-methyl imidazole (4, 4) to 2-methyl imidazole (4, 1). Further, Hirose teaches the use of these imidazoles in an epoxy resin composition.

It would have been obvious to one of ordinary skill in the art at the time of the invention to use 2-phenyl-4-methyl imidazole of Hirose in place of the imidazoles of Kunitomi because Hirose teaches the equivalence of the imidazoles.

The substitution of one known equivalent technique for another may be obvious even if the prior art does not expressly suggest the substitution (Ex parte Novak 16 USPQ 2d 2041 (BPAI 1989); In re Mostovych 144 USPQ 38 (CCPA 1964); In re Leshin 125 USPQ 416 (CCPA 1960); Graver Tank & Manufacturing Co. V. Linde Air Products Co. 85 USPQ 328 (USSC 1950).

Gilleo, Kunitomi, and Hirose fail to teach the temperature range at which the encapsulant solidifies nor the temperature range at which the encapsulant finally cures.

Barring a showing of unexpected results, it would have been obvious to one ordinary skill in the art at the time of the invention to optimize the solidification and final cure temperatures through routine experimentation (MPEP 2144.05).

Claims 3-22 and 24-31 are rejected under 35 U.S.C. 103(a) as being unpatentable over Gilleo et al., US Patent 6,194,788, in view of Kunitomi, JP 58103525, and Hirose et al., US Patent 4,546,155, as applied to claim 1 above, and further in view of Kobayashi et al., JP 62-081416A.

Kobayashi teaches an epoxy composition for sealing a semiconductor comprising an epoxy resin, a phenol type curing agent and a curing promoting agent.

It would have been obvious to one of ordinary skill in the art to use the composition of Kobayashi in the invention of Gilleo and Kunitomi because Kobayashi is relied upon to teach the conventionality of the components.

The use of conventional materials to perform there known functions in a conventional process is obvious. In re Raner 134 USPQ 343 (CCPA 1962).

Regarding claim 3, Kobayashi teaches an epoxy and a phenol, wherein the epoxy can comprise an aliphatic epoxy (3, 4th to last paragraph).

With respect to claim 4, Kobayashi teaches an epoxy novolak resin (3, 4th to last paragraph).

As to claims 5 and 6, Gilleo teaches the use of bisphenol A (4, 7+).

Regarding claims 7-11, it would have been obvious to one of ordinary skill in the art to optimize the percentage of epoxy and phenol in the epoxy/phenol admixture, and the percentage of the admixture in the whole encapsulant (MPEP 2144.05(b)).

With respect to claim 12, Kobayashi teaches the use of a triphenylphosphine and it would have been obvious to one of ordinary skill in the art to optimize the anhydride used (MPEP 2144.05(b)).

As to claim 13, it would have been obvious to one of ordinary skill in the art to optimize the imidazole-anhydride adduct used (MPEP 2144.05(b)).

Regarding claims 14 and 15, it would have been obvious to one of ordinary skill in the art to optimize the percentage of the imidazole-anhydride adduct in the encapsulant (MPEP 2144.05(b)).

With respect to claims 16-18, considering Gilleo teaches the use solvents or solvent blends that are comparable to the components selected (4, 40+), it would have been obvious to one of ordinary skill in the art to optimize the solvent selected (MPEP 2144.05(b)).

As to claim 19, it would have been obvious to one of ordinary skill in the art to optimize the percentage of solvent in the encapsulant (MPEP 2144.05(b)).

Regarding claims 20 and 21, Gilleo teaches the use of silica filler (8, 12).

With respect to claim 22, it would have been obvious to one of ordinary skill in the art to optimize the percentage of filler in the encapsulant (MPEP 2144.05(b)).

Regarding claims 24 and 25, it would have been obvious to one of ordinary skill in the art to optimize the flux used (MPEP 2144.05(b)).

With respect to claims 26 and 27, it would have been obvious to one of ordinary skill in the art to optimize the percentage of flux in the encapsulant (MPEP 2144.05(b)).

As to claim 28, Gilleo teaches the use of wetting agents, cross-linking agents and polymerization catalysts (4, 18+).

Regarding claims 29 and 30, it would have been obvious to one of ordinary skill in the art to optimize the surfactant and diluent used (MPEP 2144.05(b)).

With respect to claim 31, the B-stage processing of the encapsulant before dicing the wafer into chips is conventionally known in the art.

The use of conventional materials to perform there known functions in a conventional process is obvious. In re Raner 134 USPQ 343 (CCPA 1962).

Claim 32 is rejected under 35 U.S.C. 103(a) as being unpatentable over Gilleo et al., US Patent 6,194,788, in view of Kunitomi, JP 58103525, and Hirose et al., US Patent 4,546,155.

Gilleo teaches a wafer having B-stageable underfill composition deposited on one face of the wafer, the B-stageable composition comprising:

- a) thermal curable resin system comprising an admixture of at least one epoxy, one preferably being biphenyl A (4, 7+);
 - b) a hardener such as acid anhydrides (4, 12+);
 - c) at least one solvent (4, 40+);
 - d) at least one inorganic filler (4, 23+); and
 - e) at least one fluxing agent (4, 18+).

Gilleo fails to teach the use of an imidazole-anhydride adduct.

Kunitomi teaches an epoxy resin composition (abstract) comprising an epoxy resin; a phenol containing compound, namely a phenol novolak resin; a 2-methylimidazole/pyromellitic anhydride complex curing agent; and an inorganic filler (page 233, 2nd column, 4th to last line). Kunitomi teaches the use of a 2-phenyl imidazole, which is a non-N-substituted imidazole taught by the present app (9, 23+), in place of the 2-methylimidazole.

It would have been obvious to one of ordinary skill in the art to use the curing promoting agent of Kunitomi in the invention of Gilleo because Kunitomi teaches that the anhydride-imidazole complex provides long-term storage stability.

Kunitomi fails to teach the imidazole as being 2-phenyl-4-methyl imidazole.

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Hirose teaches the equivalence of 2-phenyl-4-methyl imidazole (4, 4) to 2-methyl imidazole (4, 1). Further, Hirose teaches the use of these imidazoles in an epoxy resin composition.

It would have been obvious to one of ordinary skill in the art at the time of the invention to use 2-phenyl-4-methyl imidazole of Hirose in place of the imidazoles of Kunitomi because Hirose teaches the equivalence of the imidazoles.

The substitution of one known equivalent technique for another may be obvious even if the prior art does not expressly suggest the substitution (Ex parte Novak 16 USPQ 2d 2041 (BPAI 1989); In re Mostovych 144 USPQ 38 (CCPA 1964); In re Leshin 125 USPQ 416 (CCPA 1960); Graver Tank & Manufacturing Co. V. Linde Air Products Co. 85 USPQ 328 (USSC 1950).

Gilleo and Kunitomi fails to teach the temperature range at which the encapsulant solidifies nor the temperature range at which the encapsulant finally cures.

Barring a showing of unexpected results, it would have been obvious to one ordinary skill in the art at the time of the invention to optimize the solidification and final cure temperatures through routine experimentation (MPEP 2144.05).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to David A. Zarneke whose telephone number is (571)-272-1937. The examiner can normally be reached on M-Th 7:30 AM-6 PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, William Baumeister can be reached on (571)-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-297-9197 (toll-free).

David A. Zarneke

Primary Examiner

August 17, 2006